

Sponsorship Prospectus

The 3rd International
Conference on
AI Sensors and
Transducers



The 3rd International Conference on AI Sensors and Transducers

02 – 07 August 2026 | Jeju, Korea

Event Chairs



Prof. Inkyu Park

Korea Advanced Institute of
Science and Technology



Prof. Zhou Li

Tsinghua University



Prof. Xinge Yu

City University of Hong Kong



Prof. Chengkuo Lee

National University of Singapore

2 to 7 August 2026, Jeju, Korea

The **first** and **second** editions of the AIS conference series in Singapore and Malaysia had attracted over 400 and 350 participants respectively. Past conference editions had attracted strong international interest, with participants and speakers from Korea, Singapore, Japan, China, the United Kingdom and the United States.

Bridging Academia and Industry: Display your brand and showcase your innovations with our researchers and leading experts at the forefront of sensors, sensing technology, AI sensors and AI-enhanced sensing systems, and transducers and AI-enhanced transducers.

For the **AI Sensors and Transducers 2026**, Don't Miss the Chance to connect with over 500 participants, including researchers from leading institutions and industry.

Symposia

- S1. Metasurface and Metaoptics
- S2. AI-Accelerated Design for Materials and Sensors
- S3. AI-Driven Biomedical Imaging and Diagnostics
- S4. AI-Enhanced Bioelectronics
- S5. AI-Driven Bio/Chemical Sensors
- S6. AI Sensors for Smart Healthcare Applications
- S7. Microfluidics, Lab-on-a-Chip and MicroTAS
- S8. Advanced Sensors for Robots and Autonomous Systems
- S9. Soft Sensors and Actuators for Human-Machine Interface
- S10. Soft Robotics Technologies
- S11. Flexible, Stretchable and Wearable Sensors
- S12. Nanogenerators and Self-Powered Sensors
- S13. Energy Harvesting Technology and Intelligent Sensing Applications
- S14. Sensing Technology for Natural and Harsh Environment

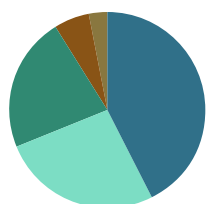
- S15. IoT Sensors and System Integration
- S16. Remote Sensing and Its Applications
- S17. Smart Cities Sensing Technologies
- S18. Cross Data for Sensing Applications
- S19. MEMS/NEMS Sensors
- S20. Wearable and Flexible Ultrasound Electronics
- S21. Optical MEMS and Photonic NEMS
- S22. Fiber Optics for Biosensing, Environmental Sensing, and Wearable Applications
- S23. Si Photonics for Sensing and Edge Computing
- S24. 2D Material-Enabled Nanosensors and Their Applications
- S25. Nanomaterials and Gas/Chemical Sensors
- S26. Smart Gas Sensors and Artificial Olfactory
- S27. Regular Symposium

Organizers:

MDPI, Sensors, Micromachines, AI Sensors,
Micro, Remote Sensing, Robotics,
Technologies, The Korean Sensors Society

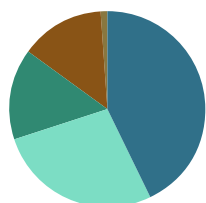


Past Attendee Profiles



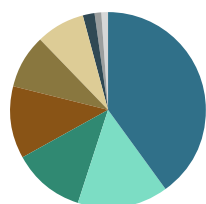
Distribution of Participants

44%	Professor
27%	Researcher
23%	Student
6%	Non-academic/Industrial Sector
3%	Other



Presentation Types

43%	Invited Speech
27%	Oral Presentation
15%	Keynote Speech
14%	Poster Presentation
1%	Plenary Speech



Distribution of Registrations by Region

40%	China
15%	Singapore
12%	Japan
12%	Korea
9%	Other Regions
8%	Taiwan
2%	India
1%	Hong Kong
1%	USA

Why Sponsor at AIS 2026 ?

Position your Brand in AI Sensors Innovation and Technology

We have an internationally diverse registrant profile, anchored by our strong influence in the Asia-Pacific market. Our networking opportunities will allow you to engage first-hand with our industry delegates and esteemed scholars from Asia and beyond.

Connect with Potential Leads and New Collaborators

Our event seeks to bridge innovation in academia, entrepreneurship and industry. Enjoy direct access and networking with our VIPs and industry leaders. We are pleased to offer you exclusive opportunities to connect at our networking activities and appreciation dinners.

Display your Innovations and Showcase your Services

There will be exhibit booths available at prominent locations within the event. Gain valuable leads from over 500+ participants, including researchers from leading institutions and industry.

Past Sponsors



AI Tools Network



Organizers:

MDPI, Sensors, Micromachines, AI Sensors, Micro, Remote Sensing, Robotics, Technologies, The Korean Sensors Society



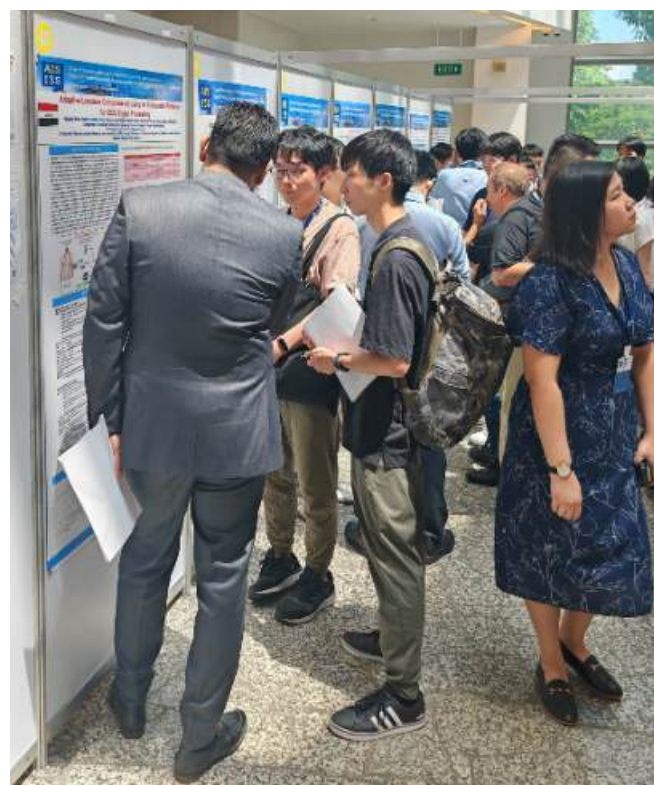
Sponsorship Packages

	Platinum €5,000	Gold €3,500	Silver €2,000	Bronze €800
Logo and link on conference webpage	✓	✓	✓	✓
Logo and Link in the conference booklet (printed version) and in the book of abstracts (online version)	✓	✓	✓	✓
Mention in the Thank You email	✓	✓	✓	✓
Exhibit Booth (1 Table)	✓	✓	✓	
Included on physical MDPI promo posters and roll-up banners	✓	✓	✓	
Complimentary Conference Registration	3	2	2	
Logo shown during Banquet or Appreciation Dinner	✓	✓		
Presentation of your company during the Banquet or Appreciation Dinner	✓			
VIP seats in conference gala dinner (1 pax only)	✓			

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Conference Gallery from Past Editions



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Other Sponsorship Opportunities

Brand Display on Event Merchandise

Options to maximize brand visibility.

Advert Page (EUR 650) 3 available

A full-page advertisement page in the conference book.

Conference Badge (EUR 1,690) 1 available

Exclusive opportunity to brand the official event badges which will be distributed to ALL conference participants and VIPs.

Conference Bag (EUR 1,690) 1 available

Exclusive opportunity to brand the official event bags which will be distributed to ALL conference participants and VIPs.

Certificate of Attendance (EUR 455) 1 available

The sponsor's logo will be displayed on the official conference certificates which will be available online to ALL participants during and after the event.

Distribution of Sponsor's Materials

Inform event participants about your company's breaking news or latest insights.

Seat Drop (EUR 390)

Sponsor's flyer will be placed at each participant's desk / seat. Sponsors will need to supply their promotional items.

Insert in Conference Bags (EUR 455)

The sponsor can insert a flyer in the conference bags which will be distributed to ALL participants. Sponsors will need to supply their promotional items.

Access and Brand Display at Conference Dinner (EUR 4,550 per day) limited slots

Enjoy 1 complimentary seating at the conference dinner, where you can network and gain valuable connections.

The sponsor can also opt to place their logo on the tables during the dinner.

Logo Placements at Strategic Locations

Strategically place your logo at locations of high traffic.

Logo Placement at Tea Breaks (EUR 1,040 per day) 3 available

The sponsor's logo will be placed on the tables during the Coffee Breaks. The Sponsor can also place max. 2 roll-up banners or posters with their information during the Coffee Break.

Logo Placement at Welcome Reception (EUR 1,690) 1 available on Day 1

The sponsor's logo will be placed on the tables at the Welcome Reception. The Sponsor can also place max. 2 roll-up banners or posters with their information during the Welcome Reception.

Logo Placement during Lunch Break (EUR 3,250) 3 available

The sponsor's logo will be placed on the tables during the Lunch Break. Sponsors are selected on a "first come, first served" basis, with a maximum of one sponsorship slot each day of the event.

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Company Details

Company _____
Street _____
P.O. Box _____
Country, postcode, place _____
Telephone _____
Website _____
E-mail address _____

Tangible Benefits

Bronze Package	Platinum Package
Silver Package	Other (please specify below)
Gold Package	

Other Sponsorship Opportunity

Additional comments

Payment

Total amount payable (EUR) _____

I will arrange a bank transfer to MDPI. Please send me the necessary payment details.

Signature and Date

The undersigned hereby registers to sponsor the conference The 3rd International Conference on AI Sensors and Transducers. The registration creates a legally binding contract between the conference and the company (sponsor). By giving a valid signature, the company agrees to the general terms and conditions as outlined below. The company agrees to recognize the rules and regulations set by the event organizer.

Signature

Date

A) Order Availability and Payment

Upon completion and submission of this order form, we will confirm to you if the selected sponsorship package for this conference is still available. In case a package is no longer available, we will offer you an alternative. You are entitled to decline the alternative proposal. MDPI reserves the right to decline an order.

The invoice for the order is payable within 30 days after receipt of the invoice.

Prices are subjected to VAT where applicable.

B) Withdrawal of the Order

If you find it necessary to withdraw your sponsorship or exhibition package, please inform us immediately at ais2026@mdpi.com. For cancellations made less than 30 days prior to the open day of the conference, MDPI reserves the right to charge 50% of the initial order unless otherwise agreed between the parties. For cancellations made less than 10 days prior to the opening day of the conference, MDPI reserves the right to charge the full amount of the initial order, unless otherwise agreed between the parties.

C) Insurance / Liability Indemnity

Liability insurance, as well as insurance against fire, explosions and natural events is obligatory for all sponsors, and must be taken out independently. MDPI is unable to take out insurance on behalf of the sponsors and cannot be held liable for any damages.

D) Complaints

Complaints concerning the conference need to be addressed to MDPI immediately at ais2026@mdpi.com.

E) Execution Disclaimer

MDPI cannot be held liable for unforeseen political, ecological, economic or other "force majeure" events and disasters that, in good faith, render it impossible to execute the conference.

F) Place of Jurisdiction

Place of jurisdiction for any disputes arising in connection with the event shall be the registered address of the conference organizer, MDPI, in Basel, Switzerland.

Return this form before 1 July 2026 to:

AI SENSORS AND TRANSDUCERS 2026 Sponsorship, MDPI
Grosspeteranlage 5
4052 Basel
Switzerland

Tel.: +41 61 683 77 34

Email: ais2026@mdpi.com

Sponsorship Cooperation Contact Information:

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Phone Number: +65 62545541

Organizers:

MDPI, Sensors, Micromachines, AI Sensors, Micro, Remote Sensing, Robotics, Technologies, The Korean Sensors Society



